



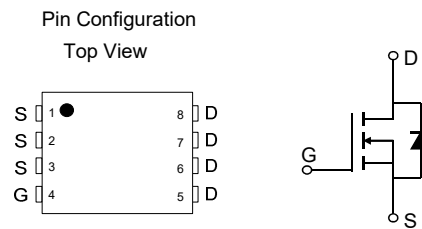
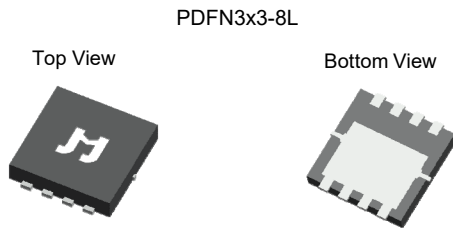
## 60V 10.0mΩ N-Ch Power MOSFET

### Features

- Low ON-resistance,  $R_{DS(ON)}$
- Low Gate Charge,  $Q_g$
- 100% UIS and  $R_g$  Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant
- AEC-Q101 Qualified for Automotive Applications

### Product Summary

| Parameter                                | Value | Unit |
|------------------------------------------|-------|------|
| $V_{DS}$                                 | 60    | V    |
| $V_{GS(th\_Typ)}$                        | 1.6   | V    |
| $I_D$ (@ $V_{GS} = 10V$ ) <sup>(1)</sup> | 36    | A    |
| $R_{DS(ON\_Typ)}$ (@ $V_{GS} = 10V$ )    | 10.0  | mΩ   |
| $R_{DS(ON\_Typ)}$ (@ $V_{GS} = 4.5V$ )   | 12.3  | mΩ   |

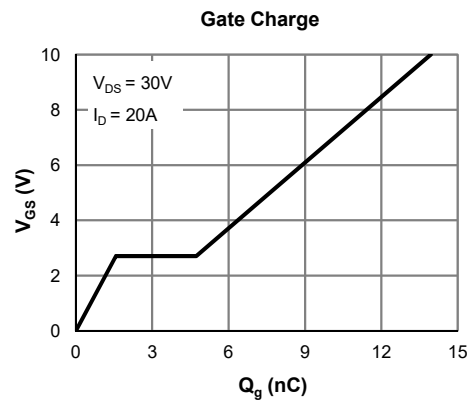
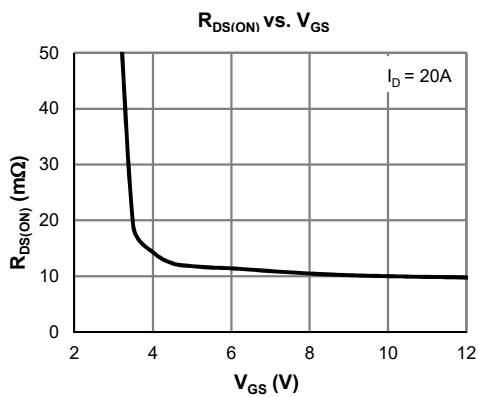


### Ordering Information

| Device         | Package    | # of Pins | Marking | MSL | $T_J$ (°C) | Media        | Quantity (pcs) |
|----------------|------------|-----------|---------|-----|------------|--------------|----------------|
| JMSL0612AUQ-13 | PDFN3x3-8L | 8         | SL0612A | 1   | -55 to 150 | 13-inch Reel | 5000           |

### Absolute Maximum Ratings (@ $T_A = 25^\circ C$ unless otherwise specified)

| Parameter                               | Symbol         | Value               | Unit |
|-----------------------------------------|----------------|---------------------|------|
| Drain-to-Source Voltage                 | $V_{DS}$       | 60                  | V    |
| Gate-to-Source Voltage                  | $V_{GS}$       | ±20                 | V    |
| Continuous Drain Current <sup>(1)</sup> | $I_D$          | $T_C = 25^\circ C$  | 36   |
|                                         |                | $T_C = 100^\circ C$ | 22   |
| Pulsed Drain Current <sup>(2)</sup>     | $I_{DM}$       | 142                 | A    |
| Avalanche Current <sup>(3)</sup>        | $I_{AS}$       | 20                  | A    |
| Avalanche Energy <sup>(3)</sup>         | $E_{AS}$       | 20                  | mJ   |
| Power Dissipation <sup>(4)</sup>        | $P_D$          | $T_C = 25^\circ C$  | 28   |
|                                         |                | $T_C = 100^\circ C$ | 11.1 |
| Junction & Storage Temperature Range    | $T_J, T_{STG}$ | -55 to 150          | °C   |



**Electrical Characteristics** (@  $T_J = 25^\circ\text{C}$  unless otherwise specified)

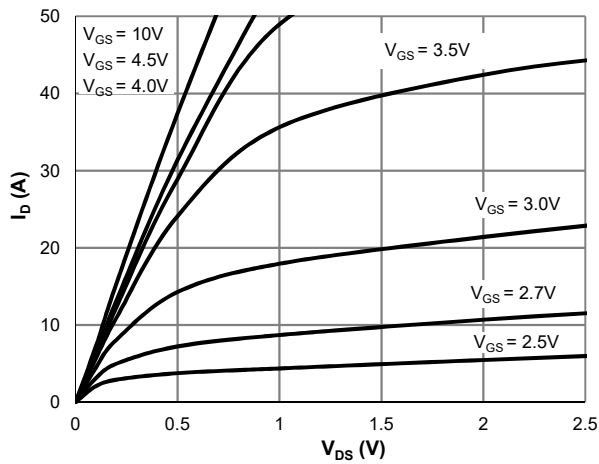
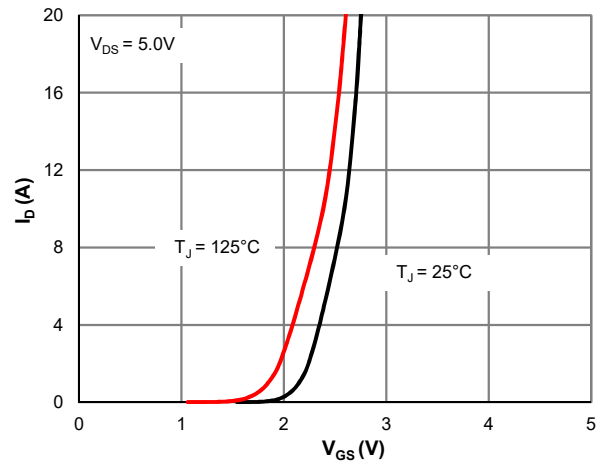
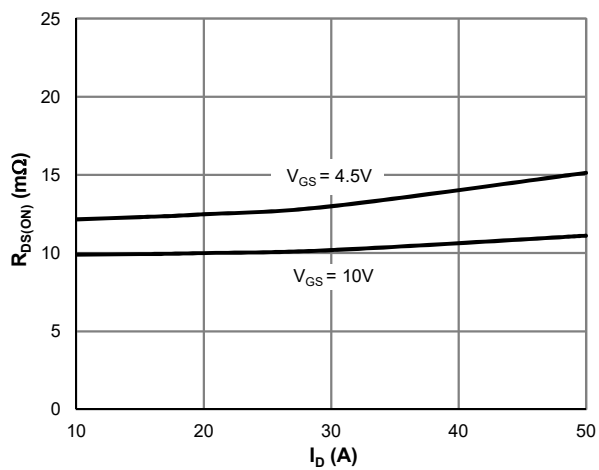
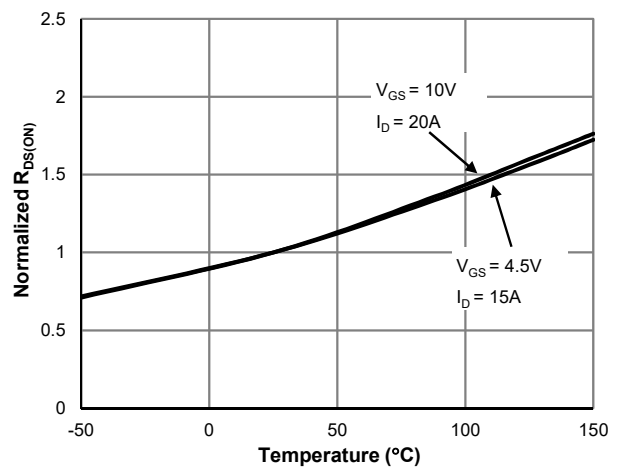
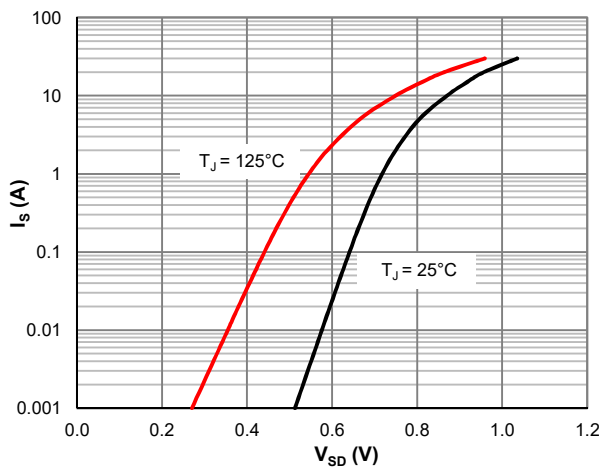
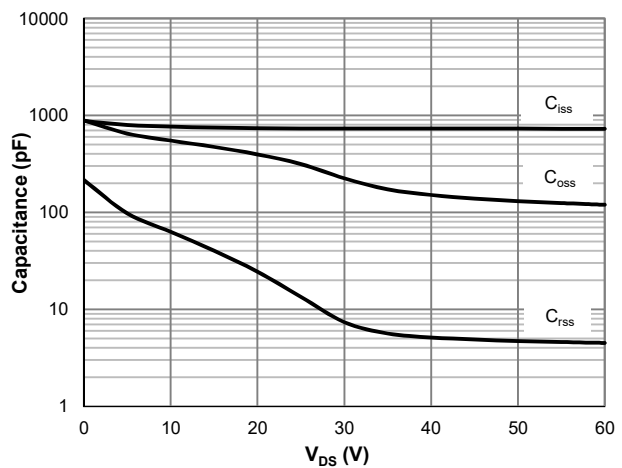
| Parameter                                     | Symbol        | Conditions                                                                         | Min. | Typ. | Max.       | Unit          |
|-----------------------------------------------|---------------|------------------------------------------------------------------------------------|------|------|------------|---------------|
| <b>STATIC PARAMETERS</b>                      |               |                                                                                    |      |      |            |               |
| Drain-Source Breakdown Voltage                | $V_{(BR)DSS}$ | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$                                         | 60   |      |            | V             |
| Zero Gate Voltage Drain Current               | $I_{DSS}$     | $V_{DS} = 48\text{V}, V_{GS} = 0\text{V}$<br>$T_J = 55^\circ\text{C}$              |      |      | 1.0<br>5.0 | $\mu\text{A}$ |
| Gate-Body Leakage Current                     | $I_{GSS}$     | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$                                      |      |      | $\pm 100$  | nA            |
| Gate Threshold Voltage                        | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$                                            | 1.2  | 1.6  | 2.5        | V             |
| Static Drain-Source ON-Resistance             | $R_{DS(on)}$  | $V_{GS} = 10\text{V}, I_D = 20\text{A}$                                            |      | 10.0 | 12.5       | m $\Omega$    |
|                                               |               | $V_{GS} = 4.5\text{V}, I_D = 15\text{A}$                                           |      | 12.3 | 16.0       | m $\Omega$    |
| Forward Transconductance                      | $g_{FS}$      | $V_{DS} = 5\text{V}, I_D = 20\text{A}$                                             |      | 81   |            | S             |
| Diode Forward Voltage                         | $V_{SD}$      | $I_S = 1\text{A}, V_{GS} = 0\text{V}$                                              |      | 0.70 | 1.0        | V             |
| Diode Continuous Current                      | $I_S$         | $T_C = 25^\circ\text{C}$                                                           |      |      | 28         | A             |
| <b>DYNAMIC PARAMETERS <sup>(5)</sup></b>      |               |                                                                                    |      |      |            |               |
| Input Capacitance                             | $C_{iss}$     | $V_{GS} = 0\text{V}, V_{DS} = 30\text{V}, f = 1\text{MHz}$                         |      | 731  |            | pF            |
| Output Capacitance                            | $C_{oss}$     |                                                                                    |      | 224  |            | pF            |
| Reverse Transfer Capacitance                  | $C_{rss}$     |                                                                                    |      | 7.4  |            | pF            |
| Gate Resistance                               | $R_g$         | $V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$                          |      | 2.5  |            | $\Omega$      |
| <b>SWITCHING PARAMETERS <sup>(5)</sup></b>    |               |                                                                                    |      |      |            |               |
| Total Gate Charge (@ $V_{GS} = 10\text{V}$ )  | $Q_g$         | $V_{GS} = 0 \text{ to } 10\text{V}$<br>$V_{DS} = 30\text{V}, I_D = 20\text{A}$     |      | 13.9 |            | nC            |
| Total Gate Charge (@ $V_{GS} = 4.5\text{V}$ ) | $Q_g$         |                                                                                    |      | 7.0  |            | nC            |
| Gate Source Charge                            | $Q_{gs}$      |                                                                                    |      | 1.6  |            | nC            |
| Gate Drain Charge                             | $Q_{gd}$      |                                                                                    |      | 3.1  |            | nC            |
| Turn-On DelayTime                             | $t_{D(on)}$   | $V_{GS} = 10\text{V}, V_{DS} = 30\text{V}$<br>$R_L = 1.5\Omega, R_{GEN} = 6\Omega$ |      | 3.7  |            | ns            |
| Turn-On Rise Time                             | $t_r$         |                                                                                    |      | 4.3  |            | ns            |
| Turn-Off DelayTime                            | $t_{D(off)}$  |                                                                                    |      | 16.2 |            | ns            |
| Turn-Off Fall Time                            | $t_f$         |                                                                                    |      | 6.5  |            | ns            |
| Body Diode Reverse Recovery Time              | $t_{rr}$      | $I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$                              |      | 24   |            | ns            |
| Body Diode Reverse Recovery Charge            | $Q_{rr}$      | $I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$                              |      | 9.3  |            | nC            |

**Thermal Performance**

| Parameter                               | Symbol          | Typ. | Max. | Unit                      |
|-----------------------------------------|-----------------|------|------|---------------------------|
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 65   | 78   | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Case    | $R_{\theta JC}$ | 4.5  | 5.2  | $^\circ\text{C}/\text{W}$ |

**Notes:**

1. Computed continuous current assumes the condition of  $T_{J\_Max}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under  $T_{J\_Max} = 150^\circ\text{C}$ .
3. This single-pulse measurement was taken under the following condition [ $L = 100\mu\text{H}, V_{GS} = 10\text{V}, V_{DD} = 30\text{V}$ ] while its value is limited by  $T_{J\_Max} = 150^\circ\text{C}$ .
4. The power dissipation  $P_D$  is based on  $T_{J\_Max} = 150^\circ\text{C}$ .
5. This value is guaranteed by design hence it is not included in the production test.

**Typical Electrical & Thermal Characteristics**

**Figure 1: Saturation Characteristics**

**Figure 2: Transfer Characteristics**

**Figure 3:  $R_{DS(ON)}$  vs. Drain Current**

**Figure 4:  $R_{DS(ON)}$  vs. Junction Temperature**

**Figure 5: Body-Diode Characteristics**

**Figure 6: Capacitance Characteristics**



### Typical Electrical & Thermal Characteristics

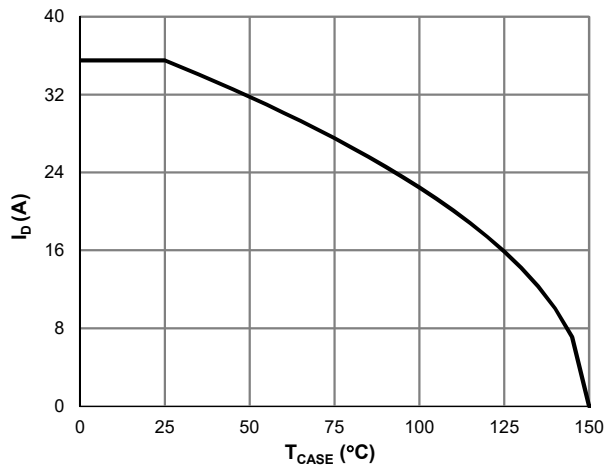


Figure 7: Current De-rating

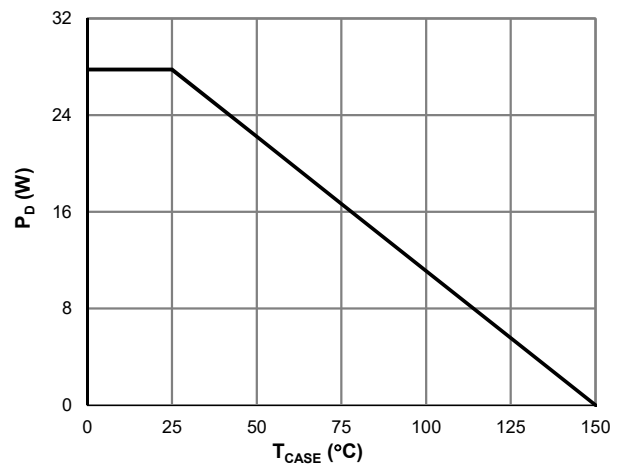


Figure 8: Power De-rating

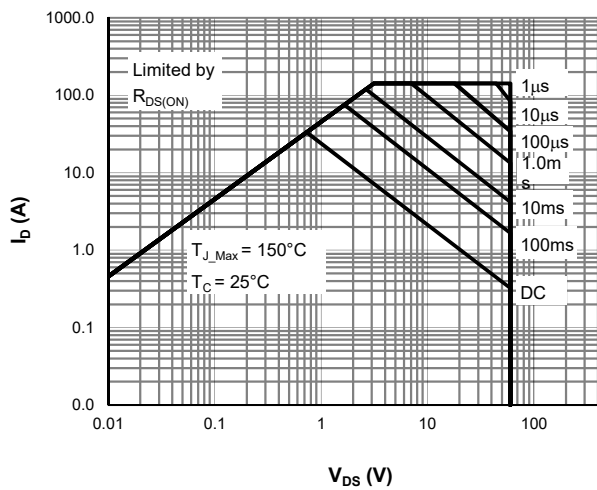


Figure 9: Maximum Safe Operating Area

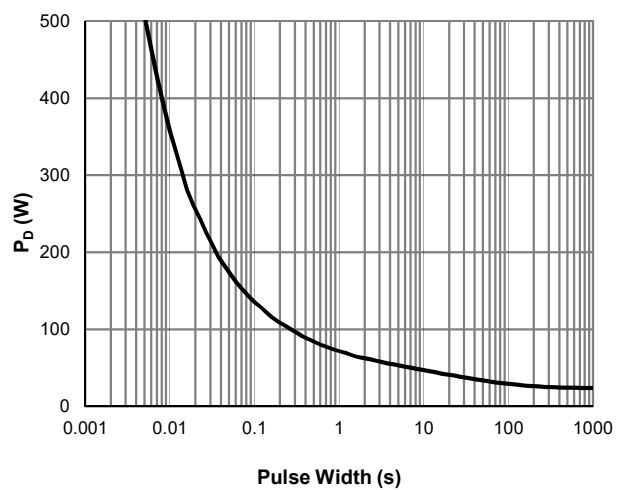


Figure 10: Single Pulse Power Rating, Junction-to-Case

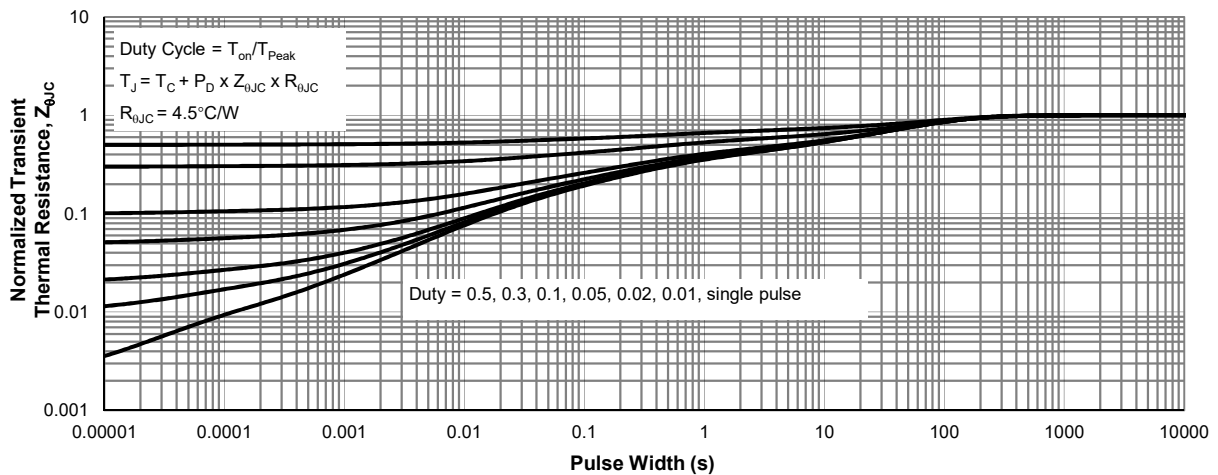
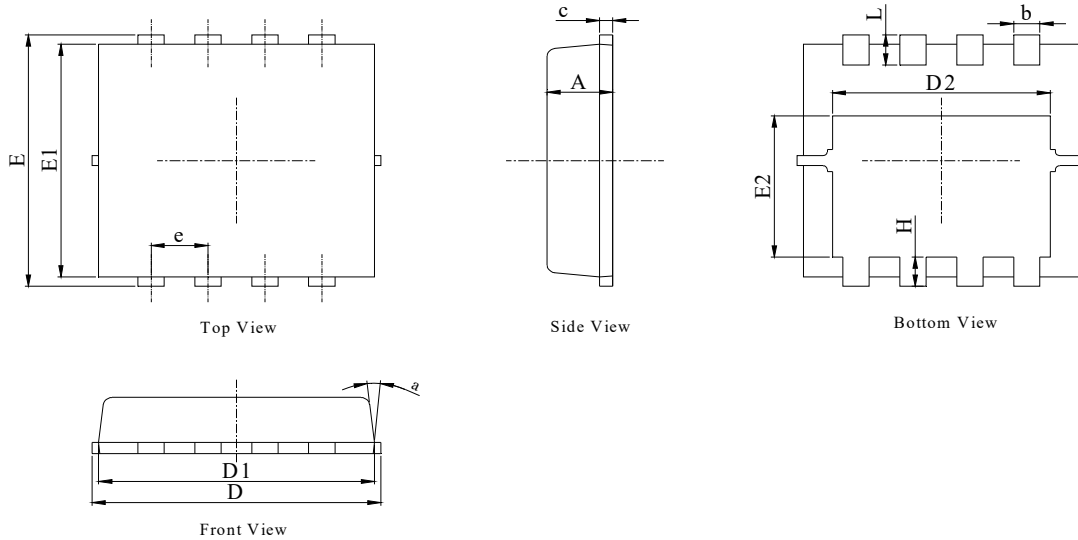
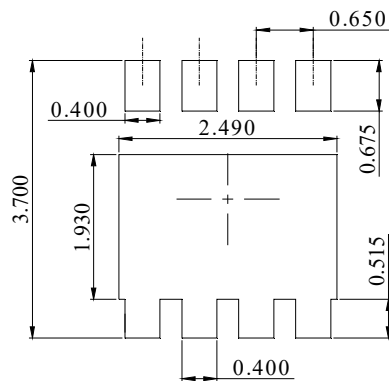


Figure 11: Normalized Maximum Transient Thermal Impedance

**PDFN3x3-8L Package Information**
**Package Outline**

**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
2. ALL DIMENSIONS IN MILLIMETER (ANGLE IN DEGREE).
3. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS.

| DIM. | MILLIMETER |      |      |
|------|------------|------|------|
|      | MIN.       | NOM. | MAX. |
| A    | 0.70       | 0.75 | 0.80 |
| b    | 0.25       | 0.30 | 0.35 |
| c    | 0.10       | 0.20 | 0.25 |
| D    | 3.00       | 3.15 | 3.25 |
| D1   | 2.95       | 3.05 | 3.15 |
| D2   | 2.39       | 2.49 | 2.59 |
| E    | 3.20       | 3.30 | 3.40 |
| E1   | 2.95       | 3.05 | 3.15 |
| E2   | 1.70       | 1.80 | 1.90 |
| e    | 0.65 BSC   |      |      |
| H    | 0.30       | 0.40 | 0.50 |
| L    | 0.25       | 0.40 | 0.50 |
| a    | ---        | ---  | 15°  |

**Recommended Soldering Footprint**


DIMENSIONS: MILLIMETERS